

Product Summary

- $V_R = 40V$
- $I_F = 0.7A$
- $I_R = 10\mu A$

Description and Applications

This compact SOT23 packaged Schottky diode offers users an excellent performance combination comprising high current operation, extremely low leakage and low forward voltage ensuring suitability for applications requiring efficient operation at higher temperatures (above 85°C) see Operational efficiency chart on page 3.

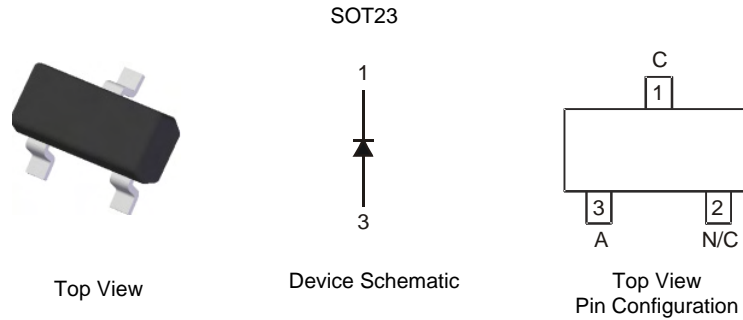
- DC – DC Converters
- Strobes
- Mobile Telecomms
- Charging circuits
- Motor Control

Features and Benefits

- Extremely low leakage (10 μA @30V)
- High current capability ($I_F = 0.7A$)
- Low V_F , fast switching Schottky
- ZLLS500 complements low temperature equivalent ZHCS500
- Package thermally rated to 150°C
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)

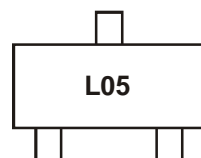


Ordering Information (Note 1)

Device	Packaging	Shipping
ZLLS500TA	SOT23	3000/Tape & Reel
ZLLS500TC	SOT23	10000/Tape & Reel

Notes: 1. For Packaging Details, go to our website at <http://www.diodes.com>.

Marking Information



L05 = Product Type Marking Code

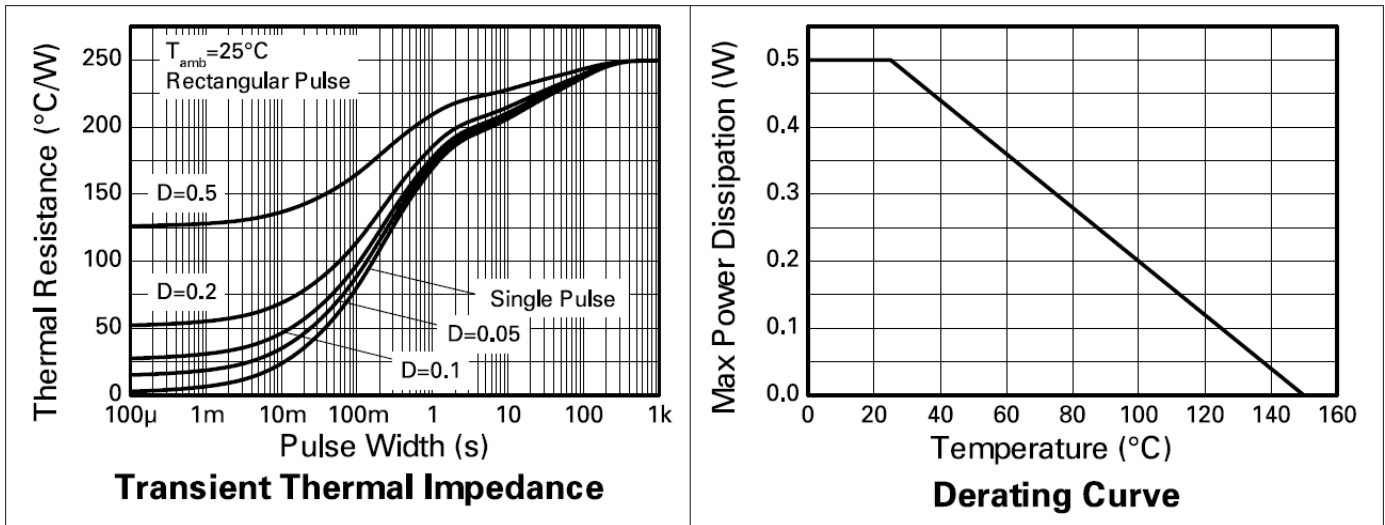
Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Continuous Reverse Voltage	V _R	40	V
Continuous Forward Current	I _F	0.7	A
Peak Repetitive Forward Current Rectangular Pulse Duty Cycle	I _{FPK}	1.14	A
Non Repetitive Forward Current		t ≤ 100μs	13
		t ≤ 10ms	3.2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, T _A = 25°C Single Die Continuous Single Die Measured at t < 5 secs	P _D	500 630	mW
Thermal Resistance, Junction to Ambient	R _{θJA}	250 198	
Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Notes: 2. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
3. For a device surface mounted on FR4 PCB measured at t < 5 secs.

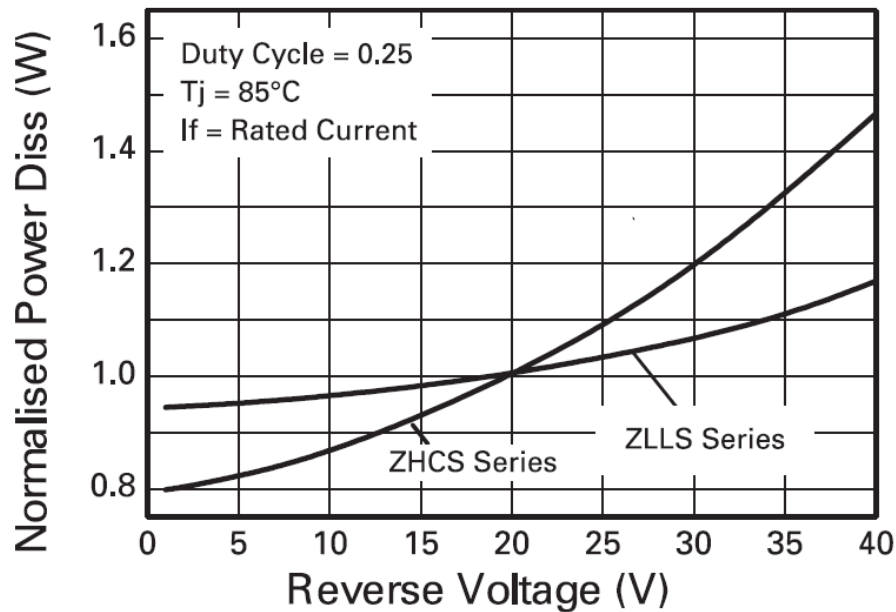


Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	-	-	V	I _R = 200μA
Forward Voltage (Note 4)	V _F	-	305	360	mV	I _F = 50mA
		-	335	390		I _F = 100mA
		-	395	450		I _F = 250mA
		-	465	530		I _F = 500mA
		-	550	630		I _F = 750mA
		-	620	710		I _F = 1A
		-	710	800		I _F = 1.5A
		-	415	-		I _F = 500mA, T _A = 100°C
Reverse Current	I _R	-	6	10	μA	V _R = 30V
		-	370	-		V _R = 30V, T _A = 85°C
Diode Capacitance	C _D	-	16	-	pF	f = 1MHz, V _R = 30V
Reverse Recovery Time	trr	-	3	-	ns	Switched from I _F = 500mA to V _R = 5.5V Measured @ I _R = 50mA
Reverse Recovery Charge	Qrr	-	210	-	pC	di/dt = 500mA/ns. R _{source} = 6Ω; R _{load} = 10Ω

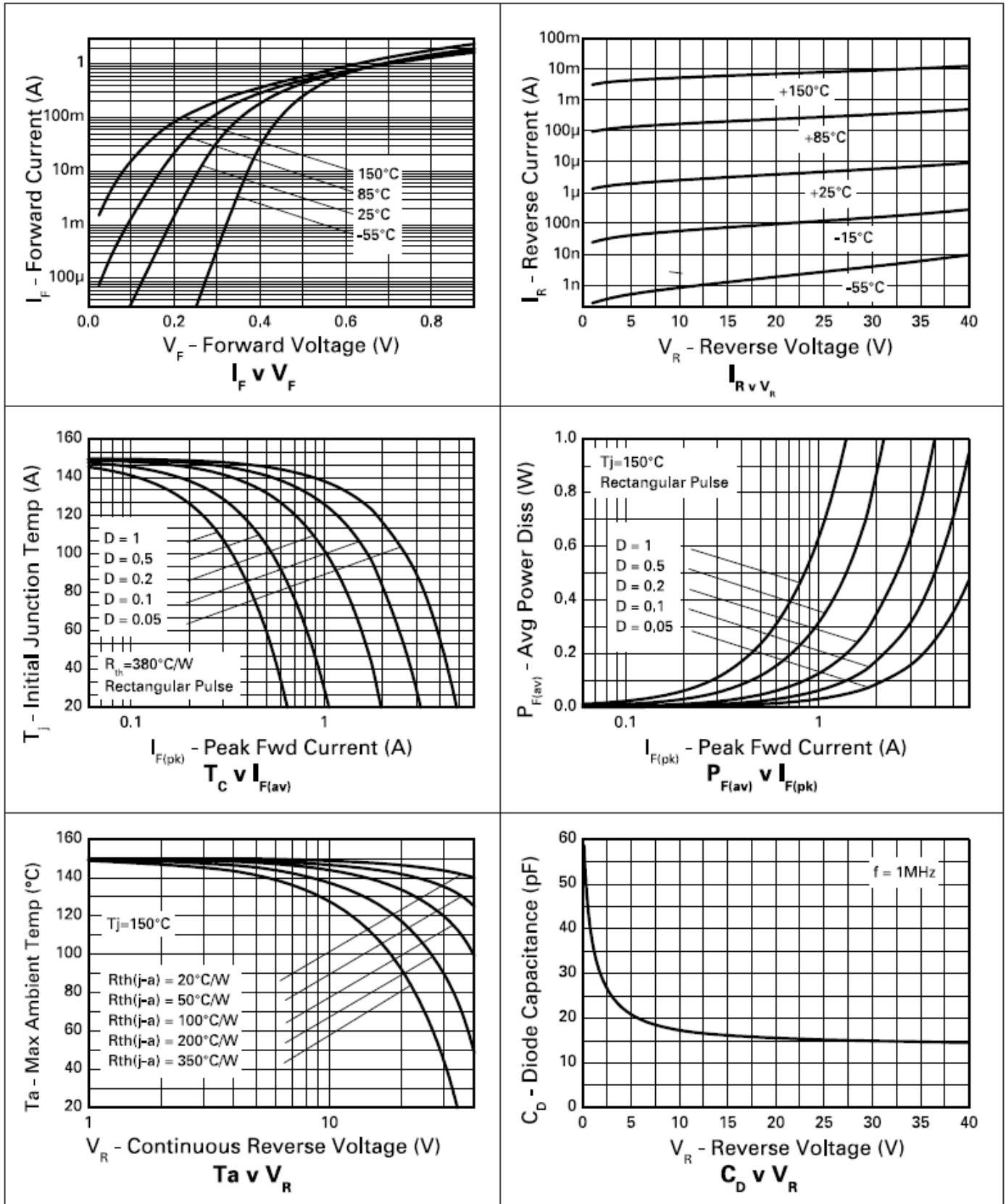
Notes: 4. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤ 2%.

Operational efficiency chart

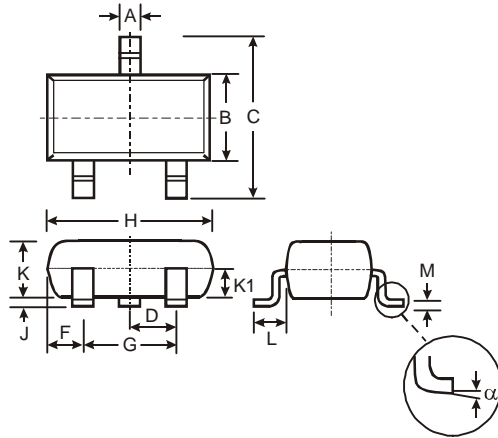


Operational Efficiency Example

The operational efficiency chart indicates the beneficial use of the ZLLS series diodes in applications requiring higher voltage, higher temperature operation. Circuits requiring low voltage low temperature operation will benefit from using Zetex low V_F ZHCS series diodes.

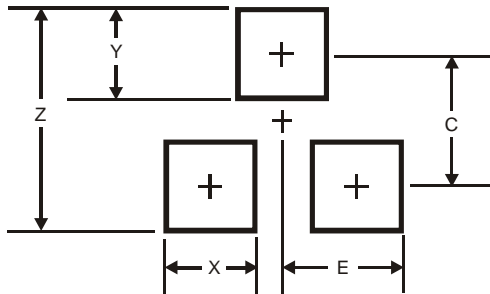


Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com